



US03-001

Serial No. 10/802,563

Please do not enter
2/8/2008
/Su Kim/

January 29, 2008

TO: Commissioner for Patents
P.O. Box 1450
VA 22313-1450

Fr: Stephen B. Ackerman, Reg. No. 37,761
28 Davis Avenue
Poughkeepsie, N.Y. 12603

Subject:

Serial No.	10/802,563	03/17/04
Hong Yu Yu et al		
"A THERMAL ROBUST SEMICONDUCTOR DEVICE USING HFN AS METAL GATE ELECTRODE AND THE MANUFACTURING PROCESS THEREOF"		
Grp. Art Unit: 2823	SU C. KIM	

RESPONSE FINAL PATENT OFFICE ACTION

Dear Sir:

In response to the Final Office Action dated November 1, 2007, please amend the above-identified application for patent as follows:

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on January 30, 2008.

Stephen B. Ackerman, Reg. No. 37,761
Signature [Signature]
Date 1/30/08

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